

### **Features**

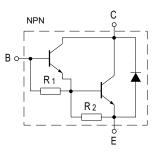
- High DC Current Gain
- Electrically Similar to Popular TIP122
- Built-in a Damper Diode at E-C

# 1.BASE 2.COLLECTOR 3.EMITTER 1

# **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)
MJD122	TO-252-2L (DPAK)	MJD122	2500

## TO-252-2L (DPAK)



R<sub>1</sub> typ. =5 K R<sub>2</sub> typ. =210

# Maximum Ratings (Ta=25 unless otherwise noted)

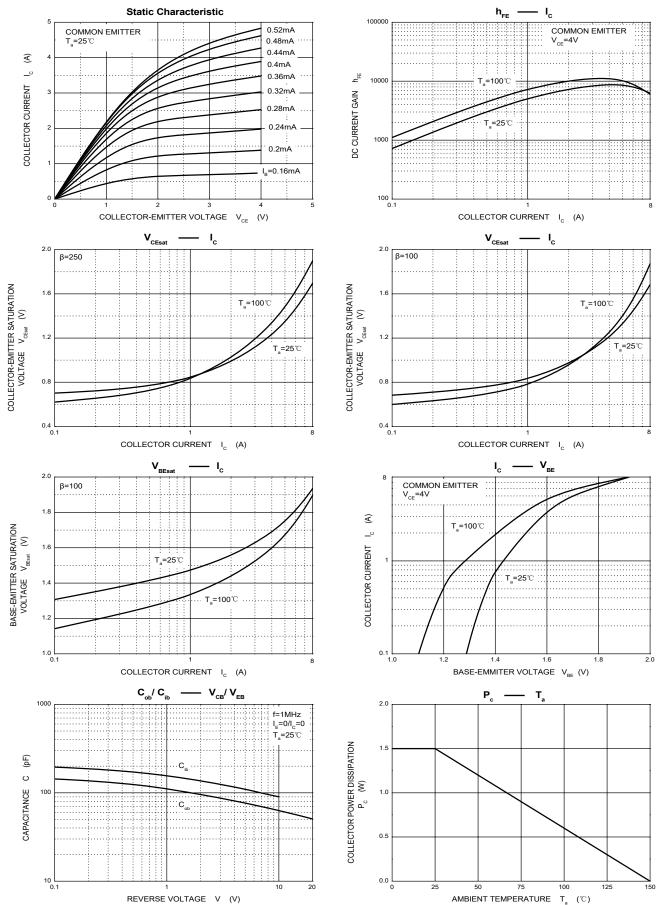
Symbol	Parameter	Value	Unit	
V <sub>CBO</sub>	Collector-Base Voltage	100	V	
V <sub>CEO</sub>	Collector-Emitter Voltage	100	V	
V <sub>EBO</sub>	Emitter-Base Voltage	5	V	
Ic	Collector Current -Continuous	8	Α	
Pc	Collector Power Dissipation	1.5	W	
T <sub>J</sub> ,T <sub>stg</sub>	Operation Junction and Storage Temperature Range	-55-150	°C	

### Electrical Characteristics (Ta=25 unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	Ic=1mA,I <sub>E</sub> =0	100			V
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	Ic=30mA,I <sub>B</sub> =0	100			V
Emitter-base breakdown voltage	V <sub>(BR)EBO</sub>	$I_E=3mA,I_C=0$	5			V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> =100V,I <sub>E</sub> =0			10	μΑ
Collector-emitter cut-off current	I <sub>CEO</sub>	V <sub>CE</sub> =50V,I <sub>E</sub> =0			10	μΑ
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> =5V,I <sub>C</sub> =0			2	mA
DO summer asia	h <sub>FE(2)</sub>	$V_{CE}=4V,I_{C}=4A$	1000		12000	
DC current gain	h <sub>FE(3)</sub>	$V_{CE}=4V,I_{C}=8A$	100			
	V <sub>CE(sat)(1)</sub>	I <sub>C</sub> =4A,I <sub>B</sub> =16mA			2	V
Collector-emitter saturation voltage	V <sub>CE(sat)(2)</sub>	I <sub>C</sub> =8A,I <sub>B</sub> =80mA			4	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> =8A,I <sub>B</sub> =80mA			4.5	V
Base-emitter voltage	$V_{BE}$	V <sub>CE</sub> =4V,I <sub>C</sub> =4A			2.8	V
Collector output capacitance	C <sub>ob</sub>	V <sub>CB</sub> =10V,I <sub>E</sub> =0,f=0.1MHz			200	pF

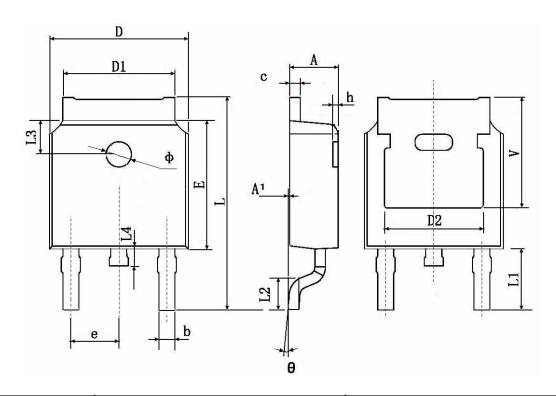


### **Typical Characteristics**





# TO-252-2L(DPAK) Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.483 TYP.		0.190 TYP.		
Е	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350 TYP.		0.211 TYP.		



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